

BFP842ESD

SiGe:C NPN RF bipolar transistor



Product description

The BFP842ESD is a high performance RF heterojunction bipolar transistor (HBT) with an integrated ESD protection suitable for 2.3 - 3.5 GHz LNA applications.



Feature list

- Unique combination of high end RF performance and robustness: 16 dBm maximum RF input power, 1 kV HBM ESD hardness
- High transition frequency $f_T = 57$ GHz to enable best in class noise performance at high frequencies:
 $NF_{min} = 0.65$ dB at 3.5 GHz, 2.5 V, 5 mA
- High gain $G_{ma} = 17.5$ dB at 3.5 GHz, 2.5 V, 15 mA
- $OIP_3 = 25.5$ dBm at 3.5 GHz, 2.5 V, 15 mA
- Suitable for low voltage applications e.g. $V_{CC} = 1.2$ V and 1.8 V (2.85 V, 3.3 V, 3.6 V require corresponding collector resistor)

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC47/20/22.

Potential applications

- Wireless communications: WLAN, WiMAX and Bluetooth
- Satellite communication systems: GNSS navigation systems (GPS, GLONASS, BeiDou, Galileo), satellite radio (SDARs, DAB) and C-band LNB (1st and 2nd stage LNA)
- Multimedia applications such as mobile/portable TV, mobile TV and FM radio
- 3G/4G UMTS/LTE mobile phone applications
- ISM applications like RKE, AMR and Zigbee

Device information

Table 1 Part information

Product name / Ordering code	Package	Pin configuration				Marking	Pieces / Reel
BFP842ESD / BFP842ESDH6327XTSA1	SOT343	1 = B	2 = E	3 = C	4 = E	T9s	3000

Attention: ESD (Electrostatic discharge) sensitive device, observe handling precautions

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Absolute maximum ratings

1 Absolute maximum ratings

Table 2 Absolute maximum ratings at $T_A = 25\text{ °C}$ (unless otherwise specified)

Parameter	Symbol	Values		Unit	Note or test condition
		Min.	Max.		
Collector emitter voltage	V_{CEO}	–	3.25	V	Open base
			2.9		$T_A = -40\text{ °C}$, open base
Collector emitter voltage ¹⁾	V_{CES}		3.25		E-B short circuited
			2.9		$T_A = -40\text{ °C}$, E-B short circuited
Collector base voltage ²⁾	V_{CBO}		4.1		Open emitter
			3.5		$T_A = -40\text{ °C}$, open emitter
Base current	I_B	-5	3	mA	
Collector current	I_C	–	40		
RF input power	P_{RFin}		16	dBm	
ESD stress pulse	V_{ESD}	-1	1	kV	HBM, all pins, acc. to JESD22-A114
Total power dissipation ³⁾	P_{tot}	–	120	mW	$T_S \leq 111\text{ °C}$
Junction temperature	T_J		150	°C	
Storage temperature	T_{Stg}		-55		

Attention: Stresses above the max. values listed here may cause permanent damage to the device. Exposure to absolute maximum rating conditions for extended periods may affect device reliability. Exceeding only one of these values may cause irreversible damage to the integrated circuit.

¹ V_{CES} is similar to V_{CEO} due to design.

² V_{CBO} is similar to V_{CEO} due to design.

³ T_S is the soldering point temperature. T_S is measured on the emitter lead at the soldering point of the PCB.

Thermal characteristics

2 Thermal characteristics

Table 3 Thermal resistance

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Junction - soldering point	R_{thJS}	–	324	–	K/W	

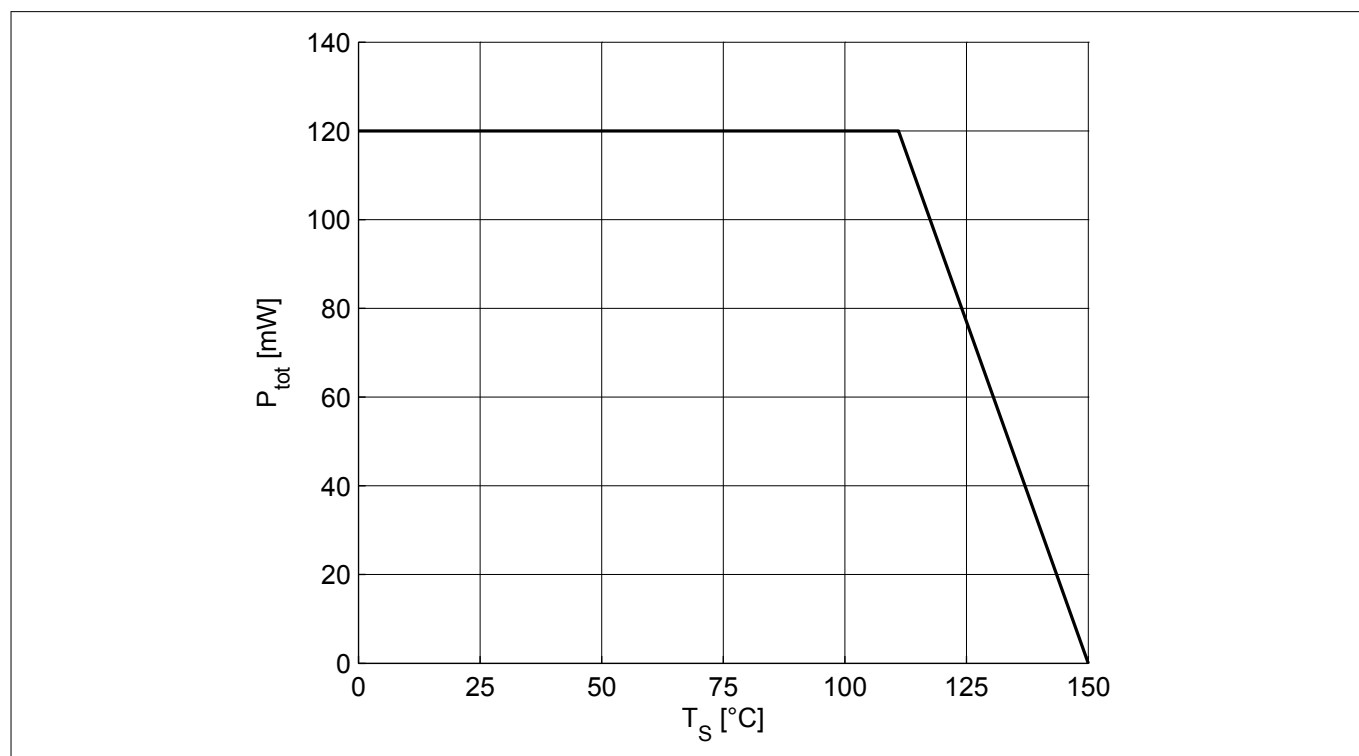


Figure 1 Total power dissipation $P_{tot} = f(T_S)$

Electrical characteristics

3 Electrical characteristics

3.1 DC characteristics

Table 4 DC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Collector emitter breakdown voltage	$V_{(BR)CEO}$	3.25	3.7	–	V	$I_C = 1\text{ mA}$, $I_B = 0$, open base
Collector emitter leakage current	I_{CES}	–	–	400 ¹⁾	nA	$V_{CE} = 2\text{ V}$, $V_{BE} = 0$, E-B short circuited
Collector base leakage current	I_{CBO}			400 ¹⁾		$V_{CB} = 2\text{ V}$, $I_E = 0$, open emitter
Emitter base leakage current	I_{EBO}			10 ¹⁾	μA	$V_{EB} = 0.5\text{ V}$, $I_C = 0$, open collector
DC current gain	h_{FE}	150	260	450		$V_{CE} = 2.5\text{ V}$, $I_C = 15\text{ mA}$, pulse measured

3.2 General AC characteristics

Table 5 General AC characteristics at $T_A = 25\text{ °C}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Transition frequency	f_T	–	57	–	GHz	$V_{CE} = 2.5\text{ V}$, $I_C = 25\text{ mA}$, $f = 1\text{ GHz}$
Collector base capacitance	C_{CB}		64		fF	$V_{CB} = 2\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, emitter grounded
Collector emitter capacitance	C_{CE}		0.46		pF	$V_{CE} = 2\text{ V}$, $V_{BE} = 0$, $f = 1\text{ MHz}$, base grounded
Emitter base capacitance	C_{EB}		0.44			$V_{EB} = 0.4\text{ V}$, $V_{CB} = 0$, $f = 1\text{ MHz}$, collector grounded

¹ Maximum values not limited by the device but by the short cycle time of the 100% test.

Electrical characteristics

3.3 Frequency dependent AC characteristics

Measurement setup is a test fixture with Bias-T's in a 50 Ω system, $T_A = 25^\circ\text{C}$.

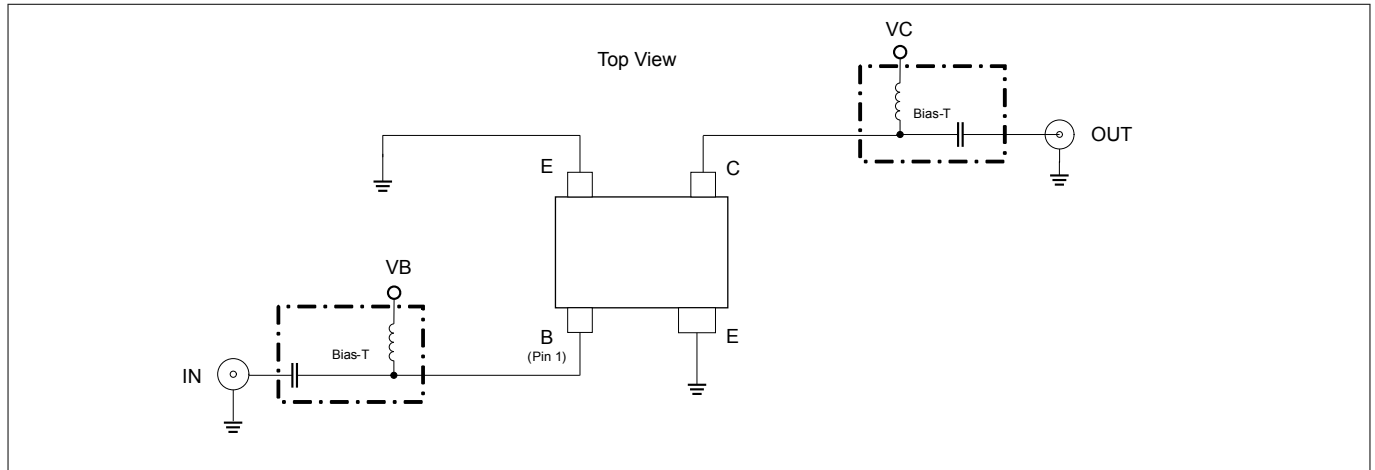


Figure 2 Testing circuit

Table 6 AC characteristics, $V_{CE} = 2.5\text{ V}$, $f = 450\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15\text{ mA}$
• Maximum power gain	G_{ms}		33			
• Transducer gain	$ S_{21} ^2$		29.5			
Noise figure						$I_C = 5\text{ mA}$
• Minimum noise figure	NF_{min}		0.4			
• Associated gain	G_{ass}		26			
Linearity					dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
• 3rd order intercept point at output	OIP_3		22			
• 1 dB gain compression point at output	OP_{1dB}		6.5			

Table 7 AC characteristics, $V_{CE} = 2.5\text{ V}$, $f = 900\text{ MHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15\text{ mA}$
• Maximum power gain	G_{ms}		29			
• Transducer gain	$ S_{21} ^2$		26			
Noise figure						$I_C = 5\text{ mA}$
• Minimum noise figure	NF_{min}		0.45			
• Associated gain	G_{ass}		24			
Linearity					dBm	$Z_S = Z_L = 50\ \Omega$, $I_C = 15\text{ mA}$
• 3rd order intercept point at output	OIP_3		22.5			
• 1 dB gain compression point at output	OP_{1dB}		7			

Electrical characteristics

Table 8 AC characteristics, $V_{CE} = 2.5 \text{ V}$, $f = 1.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15 \text{ mA}$
• Maximum power gain	G_{ms}		25.5			
• Transducer gain	$ S_{21} ^2$		23			
Noise figure						
• Minimum noise figure	NF_{min}		0.45			$I_C = 5 \text{ mA}$
• Associated gain	G_{ass}		21			
Linearity					dBm	$Z_S = Z_L = 50 \Omega$, $I_C = 15 \text{ mA}$
• 3rd order intercept point at output	OIP_3		23.5			
• 1 dB gain compression point at output	OP_{1dB}		7.5			

Table 9 AC characteristics, $V_{CE} = 2.5 \text{ V}$, $f = 1.9 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15 \text{ mA}$
• Maximum power gain	G_{ms}		23.5			
• Transducer gain	$ S_{21} ^2$		21			
Noise figure						
• Minimum noise figure	NF_{min}		0.5			$I_C = 5 \text{ mA}$
• Associated gain	G_{ass}		19.5			
Linearity					dBm	$Z_S = Z_L = 50 \Omega$, $I_C = 15 \text{ mA}$
• 3rd order intercept point at output	OIP_3		24.5			
• 1 dB gain compression point at output	OP_{1dB}		8			

Table 10 AC characteristics, $V_{CE} = 2.5 \text{ V}$, $f = 2.4 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15 \text{ mA}$
• Maximum power gain	G_{ms}		22			
• Transducer gain	$ S_{21} ^2$		19			
Noise figure						
• Minimum noise figure	NF_{min}		0.5			$I_C = 5 \text{ mA}$
• Associated gain	G_{ass}		18			
Linearity					dBm	$Z_S = Z_L = 50 \Omega$, $I_C = 15 \text{ mA}$
• 3rd order intercept point at output	OIP_3		25			
• 1 dB gain compression point at output	OP_{1dB}		8			

Electrical characteristics

Table 11 AC characteristics, $V_{CE} = 2.5 \text{ V}$, $f = 3.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15 \text{ mA}$
• Maximum power gain	G_{ma}		17.5			
• Transducer gain	$ S_{21} ^2$		16			$I_C = 5 \text{ mA}$
Noise figure						
• Minimum noise figure	NF_{min}		0.65		dBm	$Z_S = Z_L = 50 \Omega$, $I_C = 15 \text{ mA}$
• Associated gain	G_{ass}		15			
Linearity						
• 3rd order intercept point at output	OIP_3		25.5			
• 1 dB gain compression point at output	OP_{1dB}		8.5			

Table 12 AC characteristics, $V_{CE} = 2.5 \text{ V}$, $f = 5.5 \text{ GHz}$

Parameter	Symbol	Values			Unit	Note or test condition
		Min.	Typ.	Max.		
Power gain		–		–	dB	$I_C = 15 \text{ mA}$
• Maximum power gain	G_{ma}		12.5			
• Transducer gain	$ S_{21} ^2$		11.5			$I_C = 5 \text{ mA}$
Noise figure						
• Minimum noise figure	NF_{min}		0.85		dBm	$Z_S = Z_L = 50 \Omega$, $I_C = 15 \text{ mA}$
• Associated gain	G_{ass}		10.5			
Linearity						
• 3rd order intercept point at output	OIP_3		24			
• 1 dB gain compression point at output	OP_{1dB}		8			

Note: $G_{ms} = |S_{21}| / |S_{12}|$ for $k < 1$; $G_{ma} = |S_{21}| / |S_{12}| (k - (k^2 - 1)^{1/2})$ for $k > 1$. In order to get the NF_{min} values stated in this chapter, the test fixture losses have been subtracted from all measured results. OIP_3 value depends on termination of all intermodulation frequency components. Termination used for this measurement is 50Ω from 0.2 MHz to 12 GHz.

Electrical characteristics

3.4 Characteristic DC diagrams

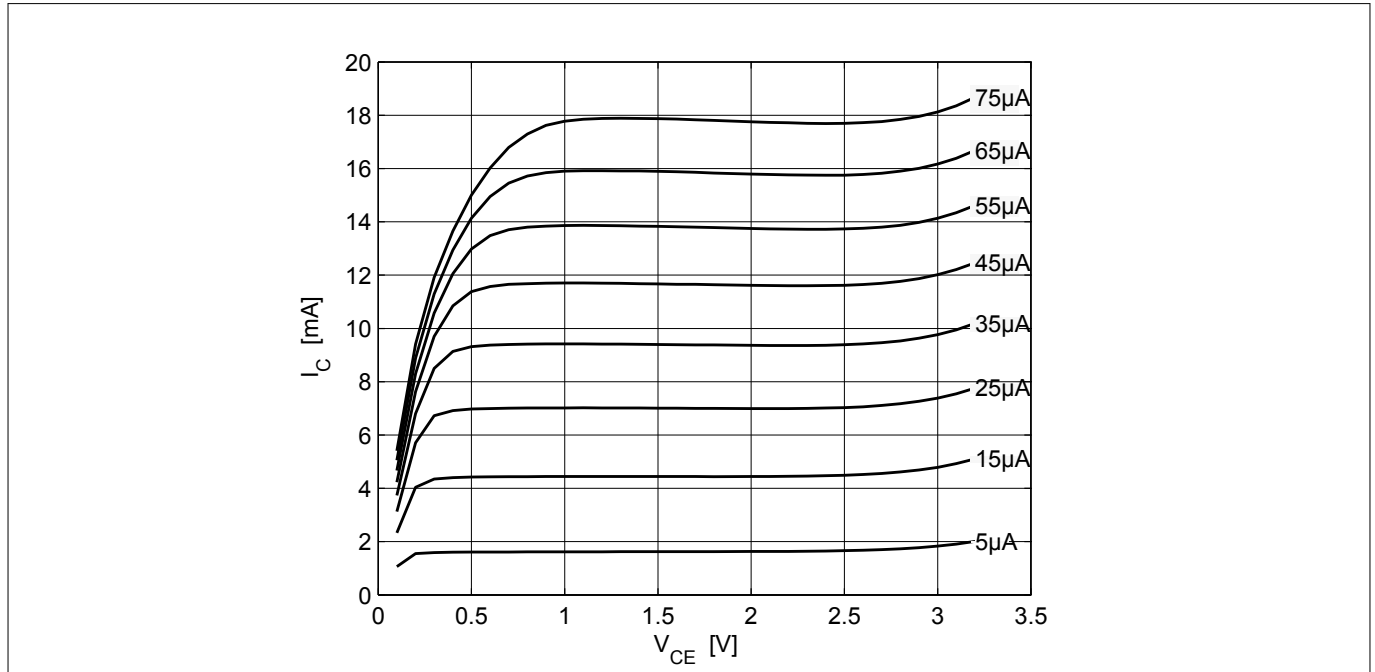


Figure 3 Collector current vs. collector emitter voltage $I_C = f(V_{CE})$, $I_B = \text{parameter}$

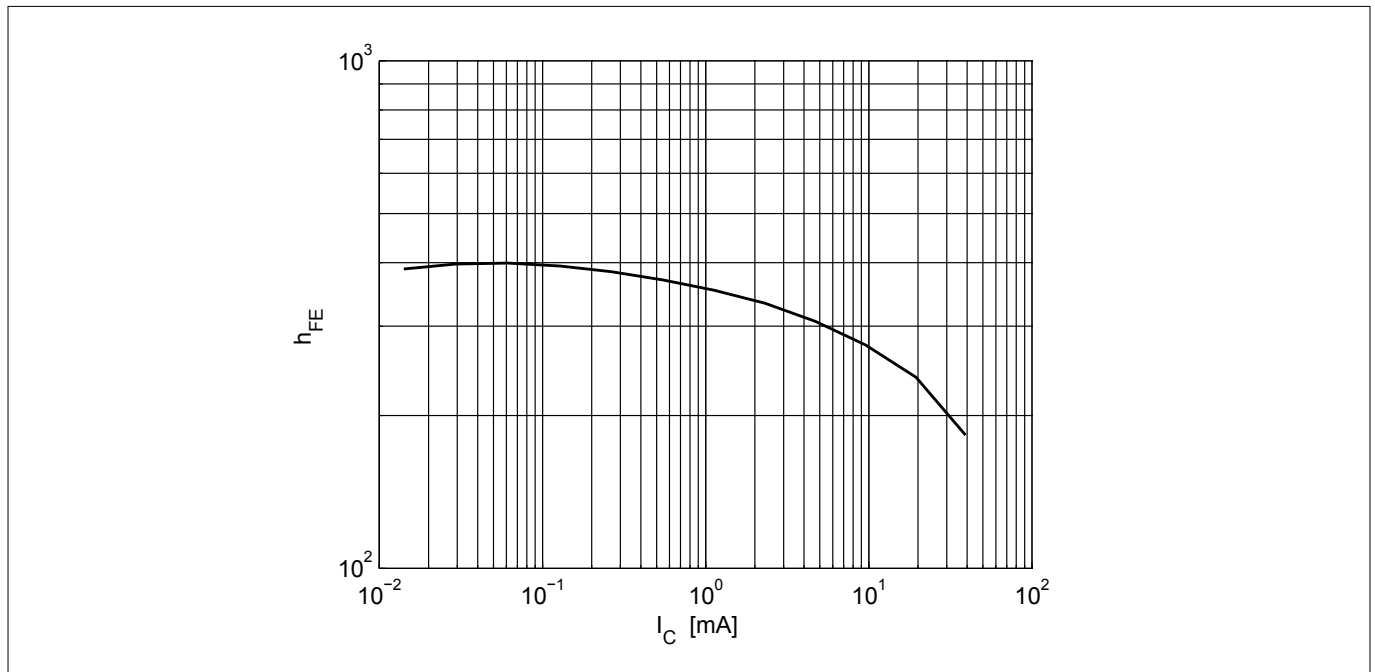


Figure 4 DC current gain $h_{FE} = f(I_C)$, $V_{CE} = 2.5 \text{ V}$

Electrical characteristics

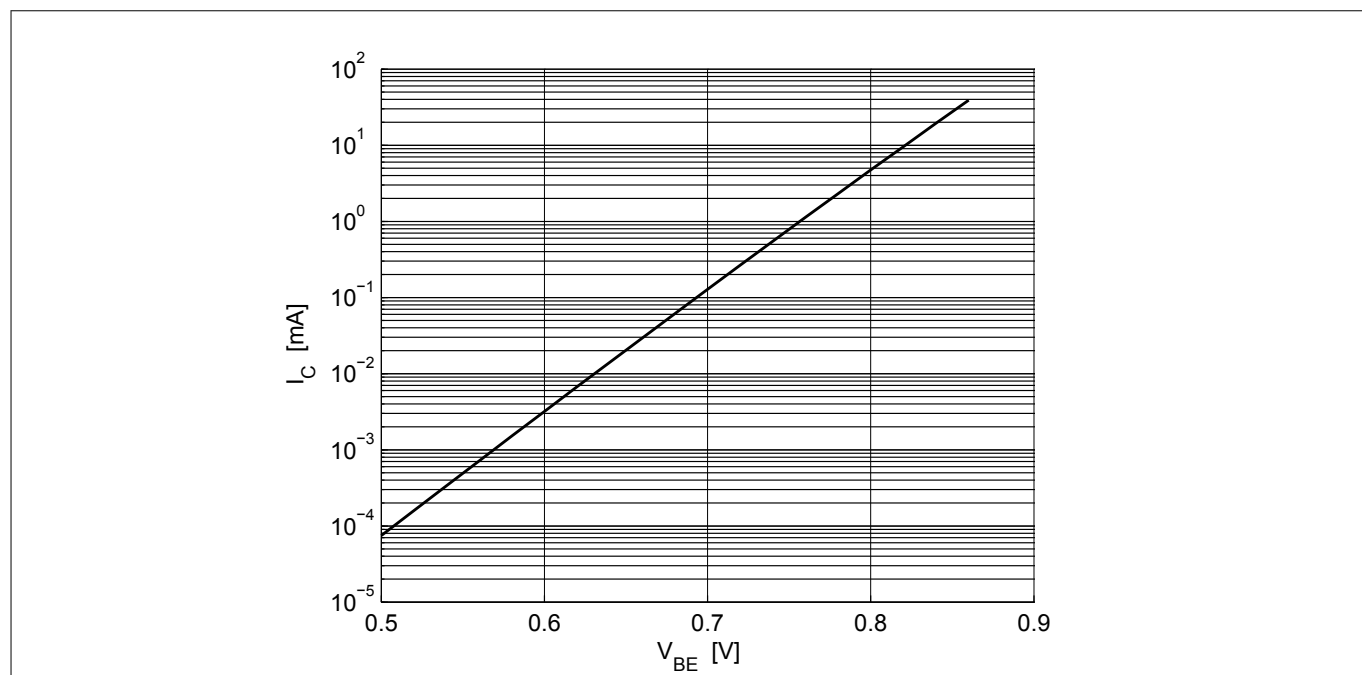


Figure 5 Collector current vs. base emitter forward voltage $I_C = f(V_{BE})$, $V_{CE} = 2.5$ V

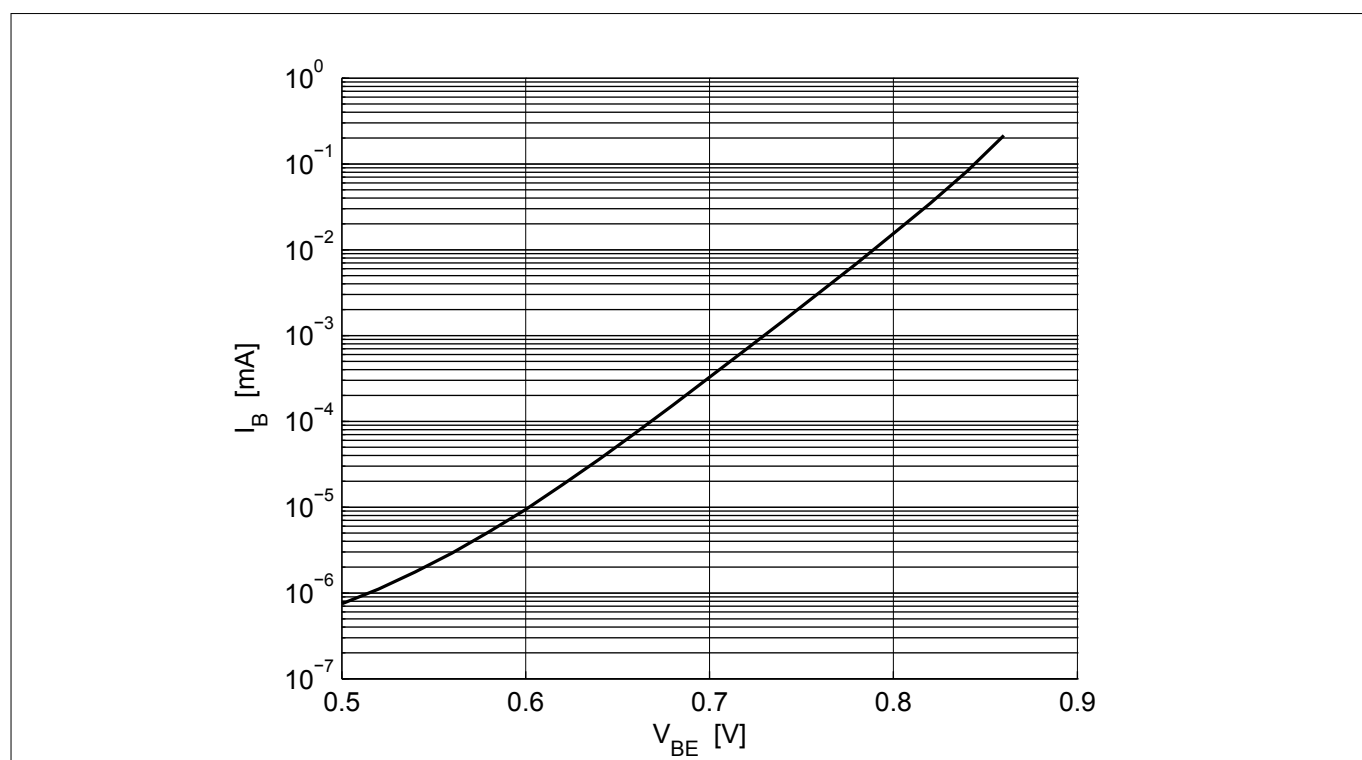


Figure 6 Base current vs. base emitter forward voltage $I_B = f(V_{BE})$, $V_{CE} = 2.5$ V

Electrical characteristics

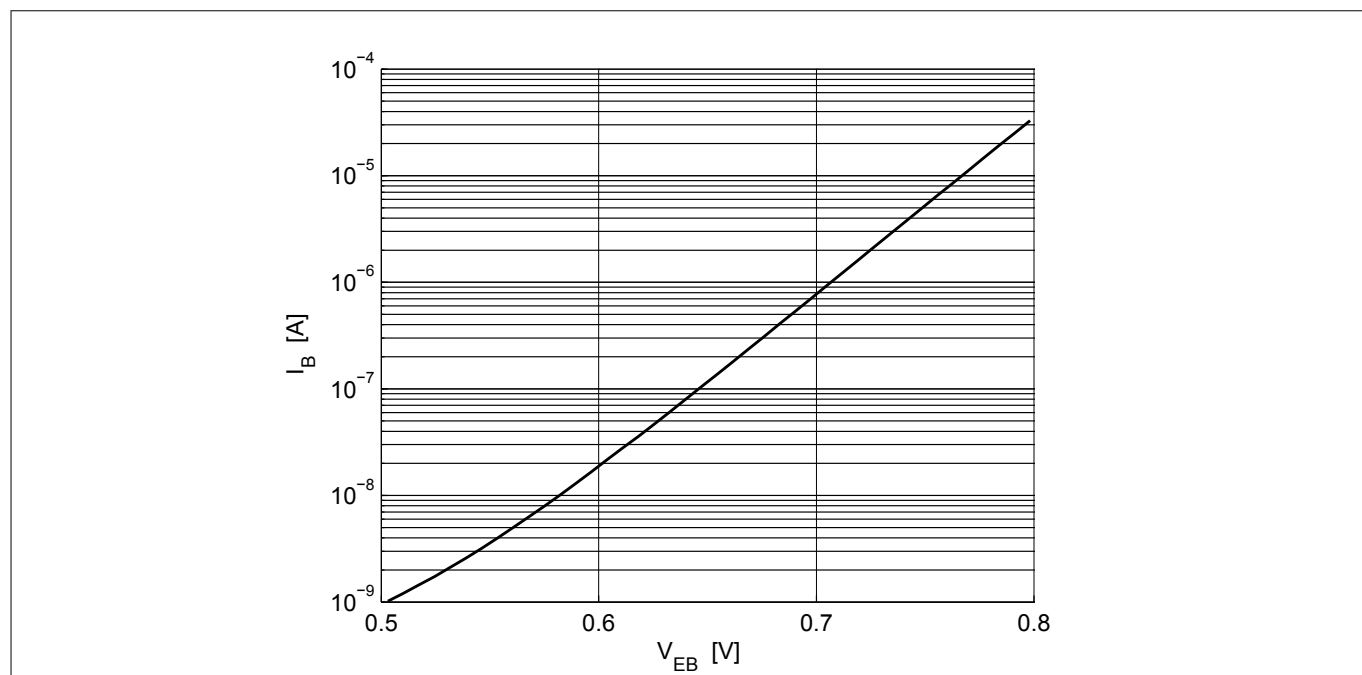


Figure 7 **Base current vs. base emitter reverse voltage $I_B = f(V_{EB})$, $V_{CE} = 2.5$ V**

Electrical characteristics

3.5 Characteristic AC diagrams

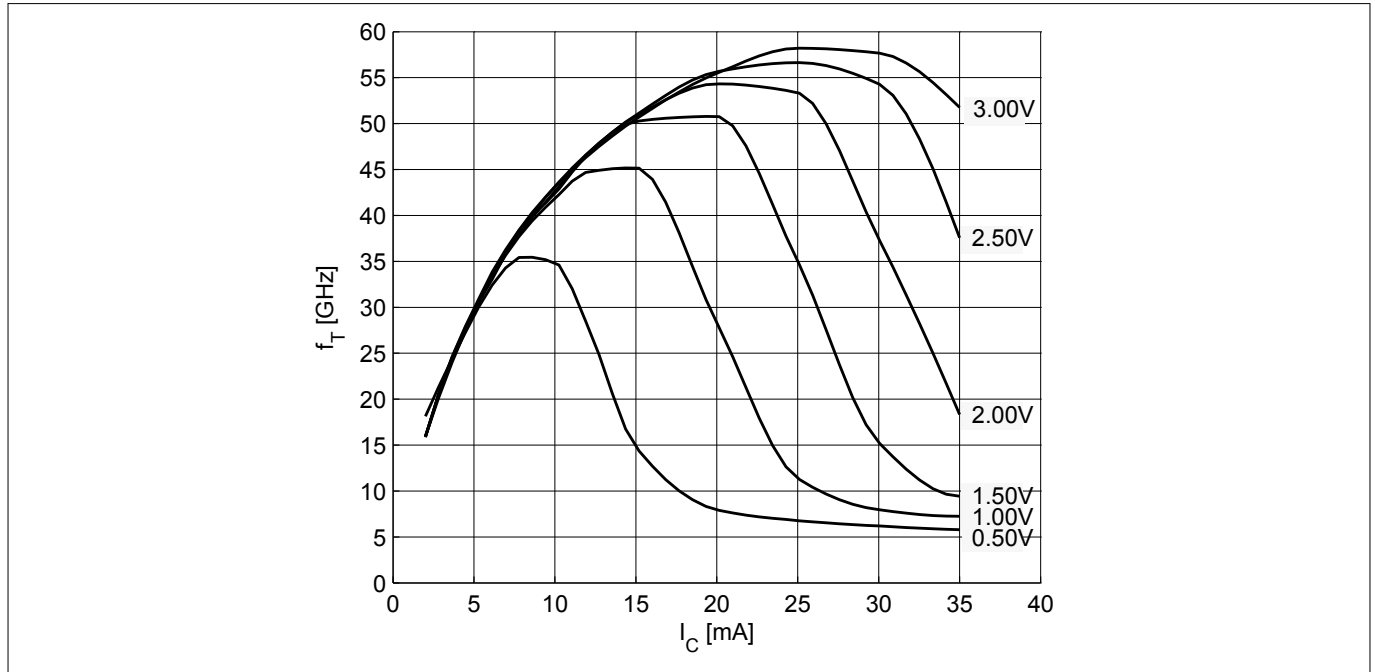


Figure 8 Transition frequency $f_T = f(I_C)$, $f = 1$ GHz, $V_{CE} = \text{parameter}$

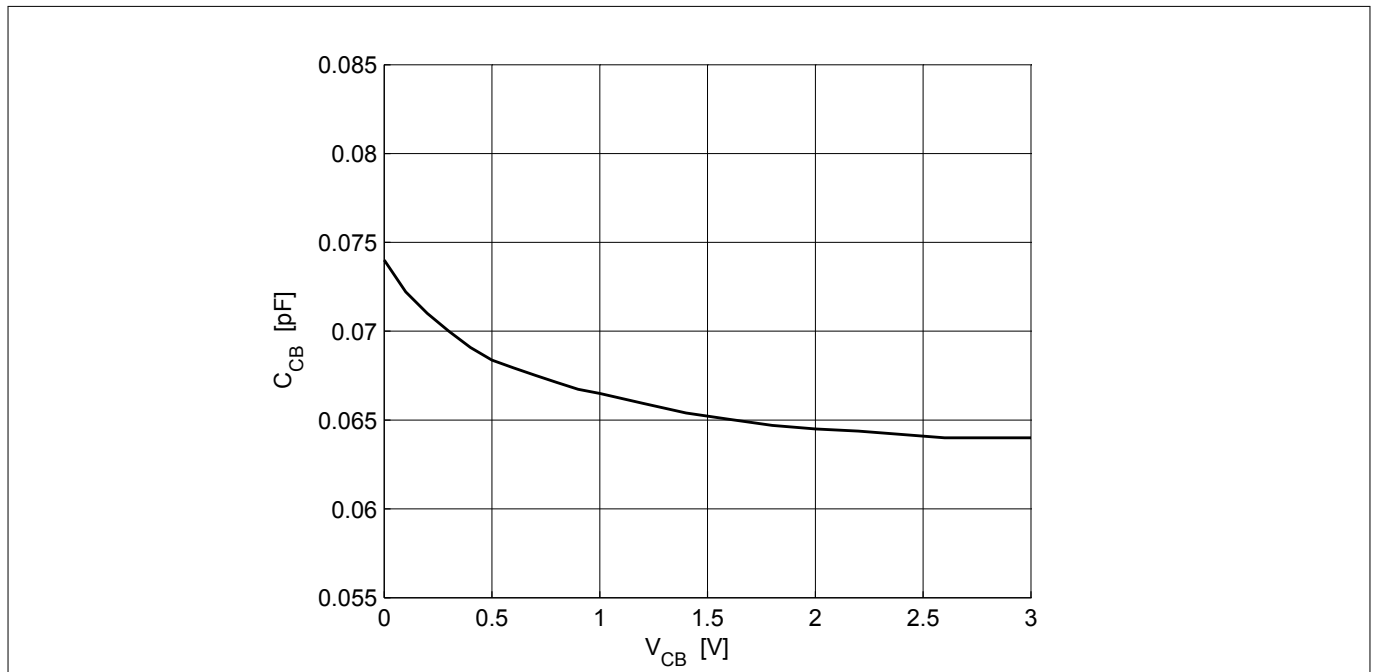


Figure 9 Collector base capacitance $C_{CB} = f(V_{CB})$, $f = 1$ MHz

Electrical characteristics

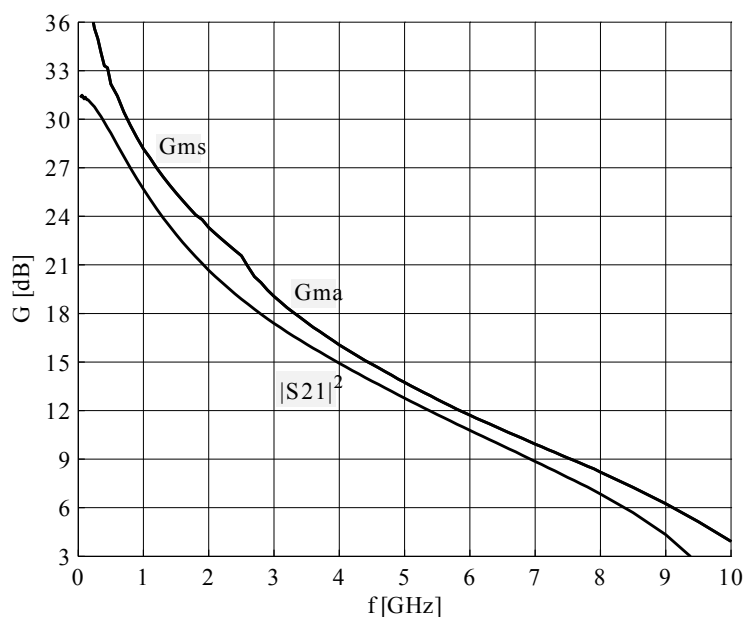


Figure 10 Gain G_{ma} , G_{ms} , $|S_{21}|^2 = f(f)$, $V_{CE} = 2.5\text{ V}$, $I_C = 15\text{ mA}$

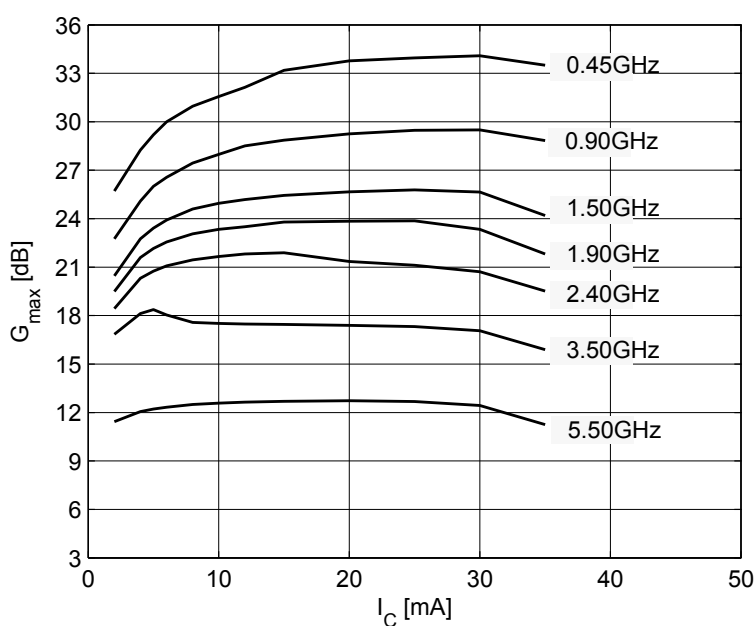


Figure 11 Maximum power gain $G_{max} = f(I_C)$, $V_{CE} = 2.5\text{ V}$, $f = \text{parameter}$

Electrical characteristics

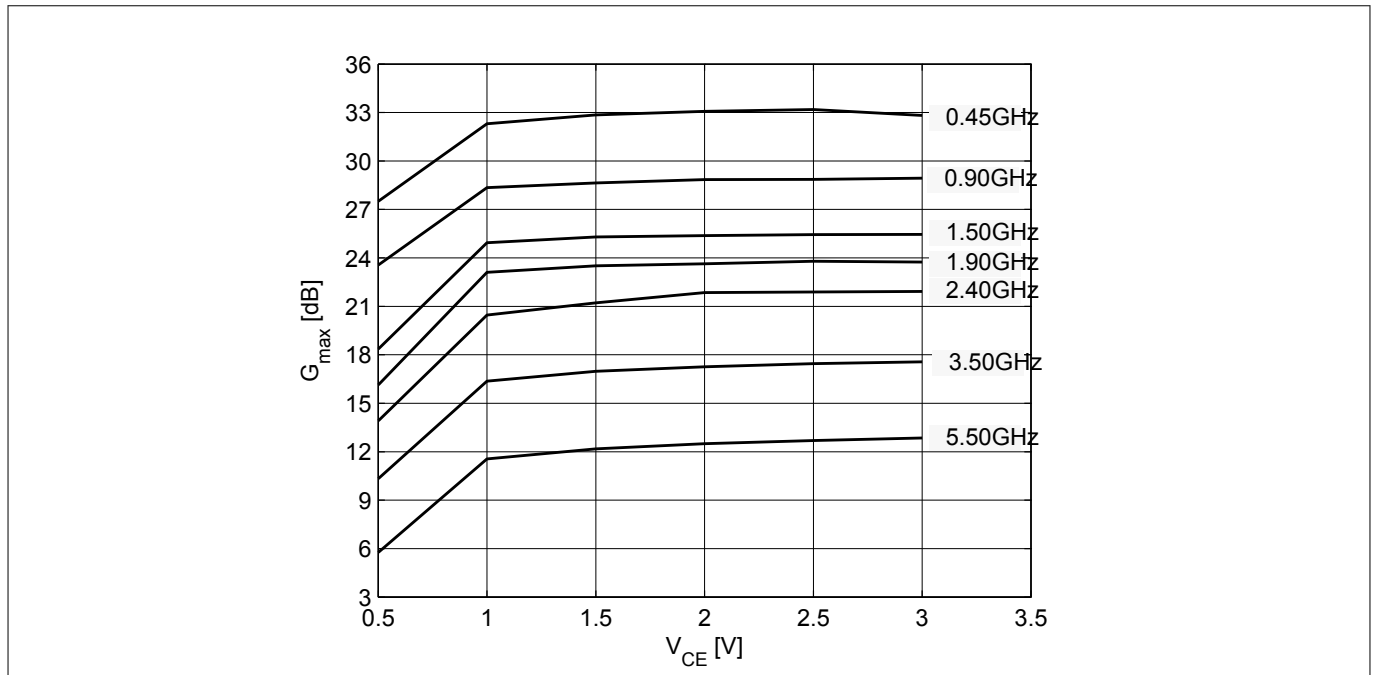


Figure 12 Maximum power gain $G_{max} = f(V_{CE})$, $I_C = 15$ mA, $f =$ parameter

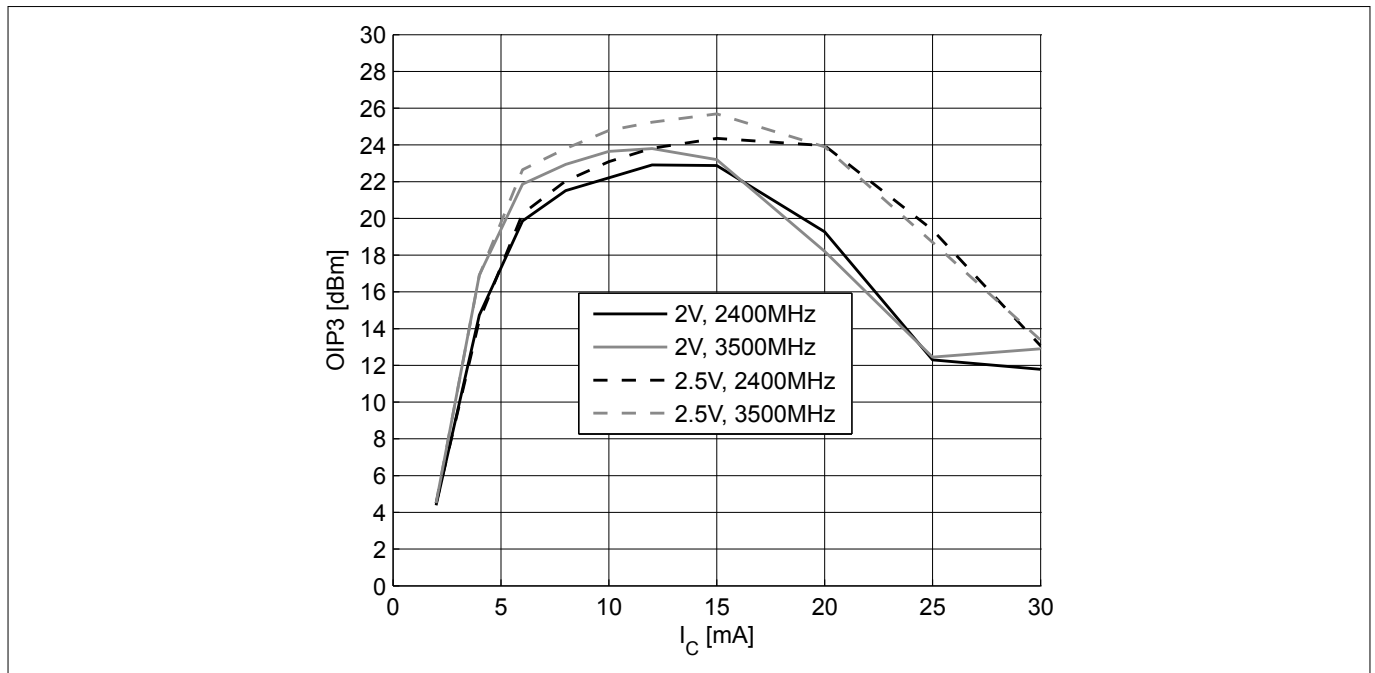


Figure 13 3rd order intercept point at output $OIP_3 = f(I_C)$, $Z_S = Z_L = 50 \Omega$, V_{CE} , $f =$ parameter

Electrical characteristics

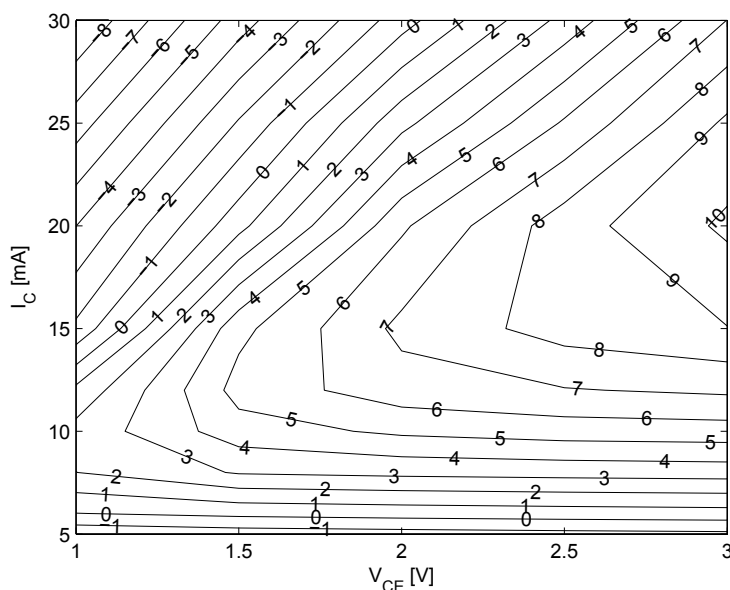


Figure 14 Compression point at output $OP_{1dB} [dBm] = f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 3.5 \text{ GHz}$

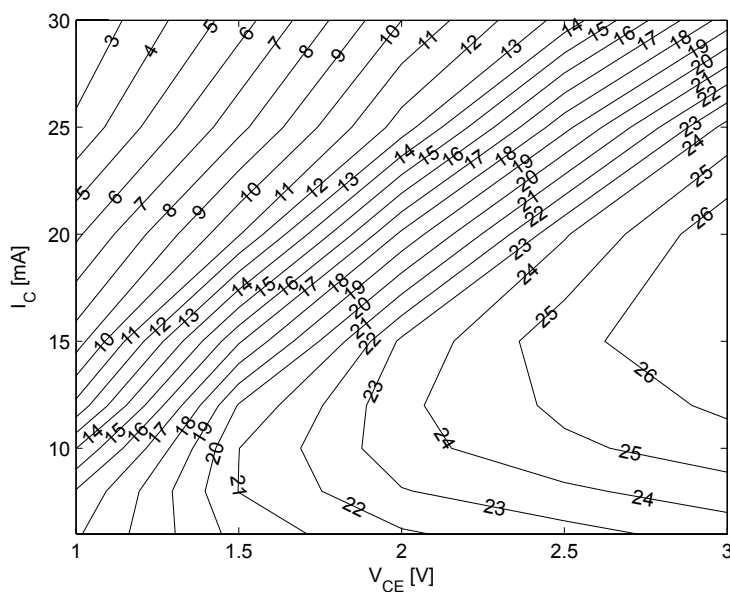


Figure 15 3rd order intercept point at output $OIP_3 [dBm] = f(I_C, V_{CE})$, $Z_S = Z_L = 50 \Omega$, $f = 3.5 \text{ GHz}$

Electrical characteristics

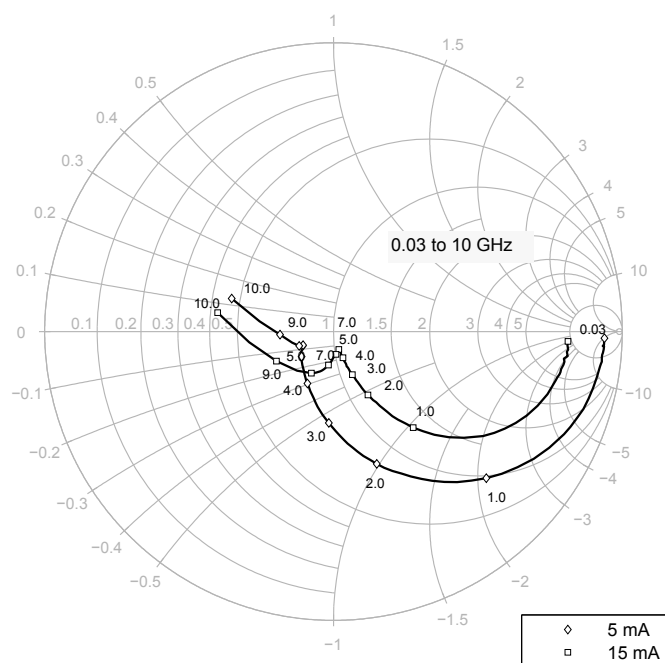


Figure 16 Input reflection coefficient $S_{11} = f(f)$, $V_{CE} = 2.5 \text{ V}$, $I_C = 5 / 15 \text{ mA}$

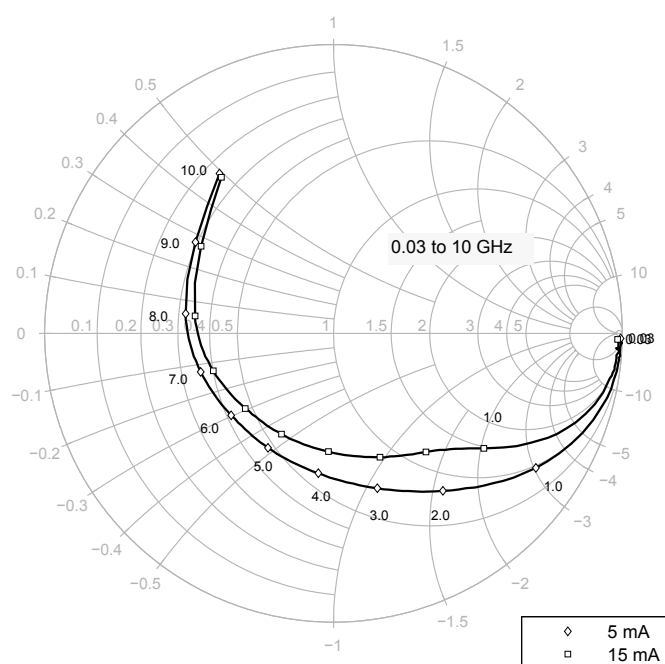


Figure 17 Output reflection coefficient $S_{22} = f(f)$, $V_{CE} = 2.5 \text{ V}$, $I_C = 5 / 15 \text{ mA}$

Electrical characteristics

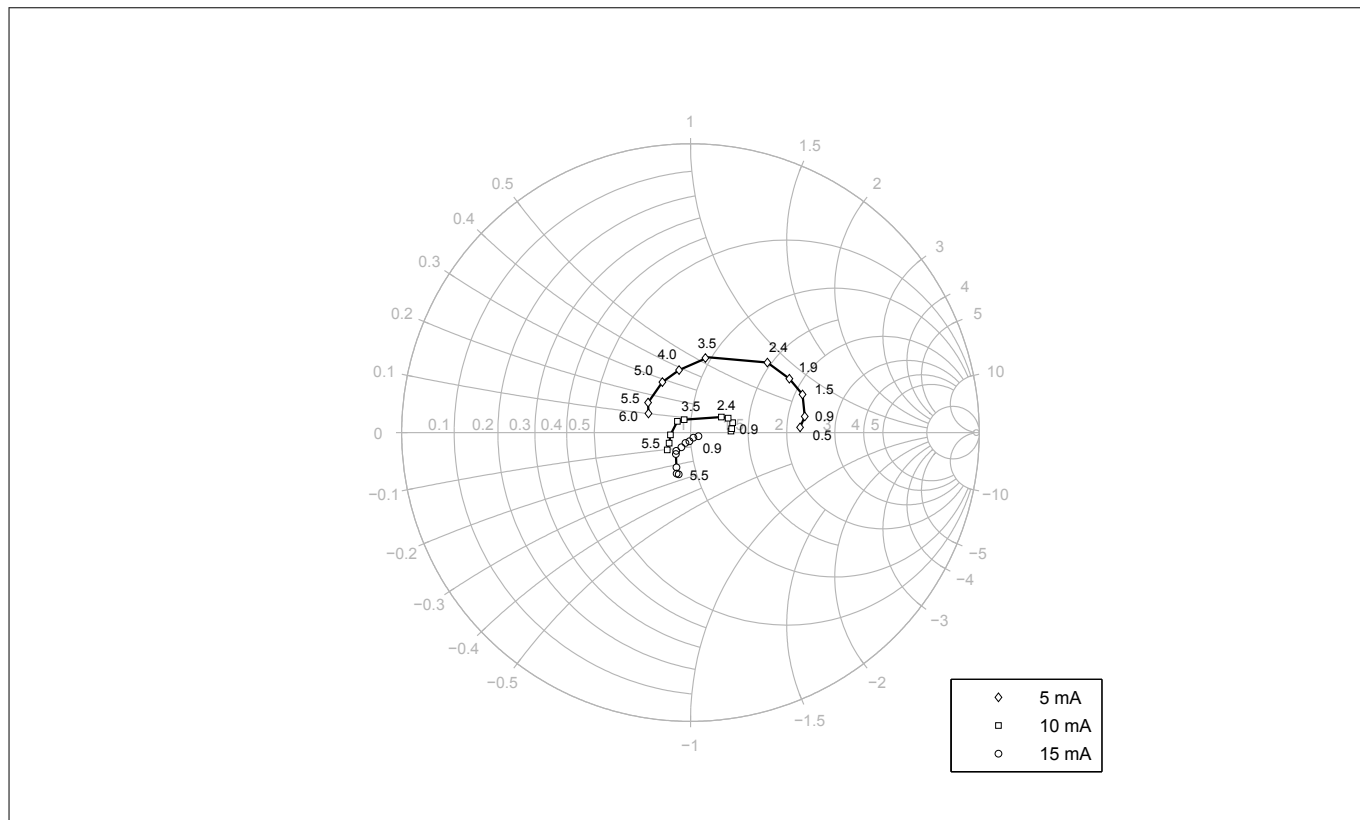


Figure 18 Source impedance for minimum noise figure $Z_{S,opt} = f(f)$, $V_{CE} = 2.5 \text{ V}$, $I_C = 5 / 10 / 15 \text{ mA}$

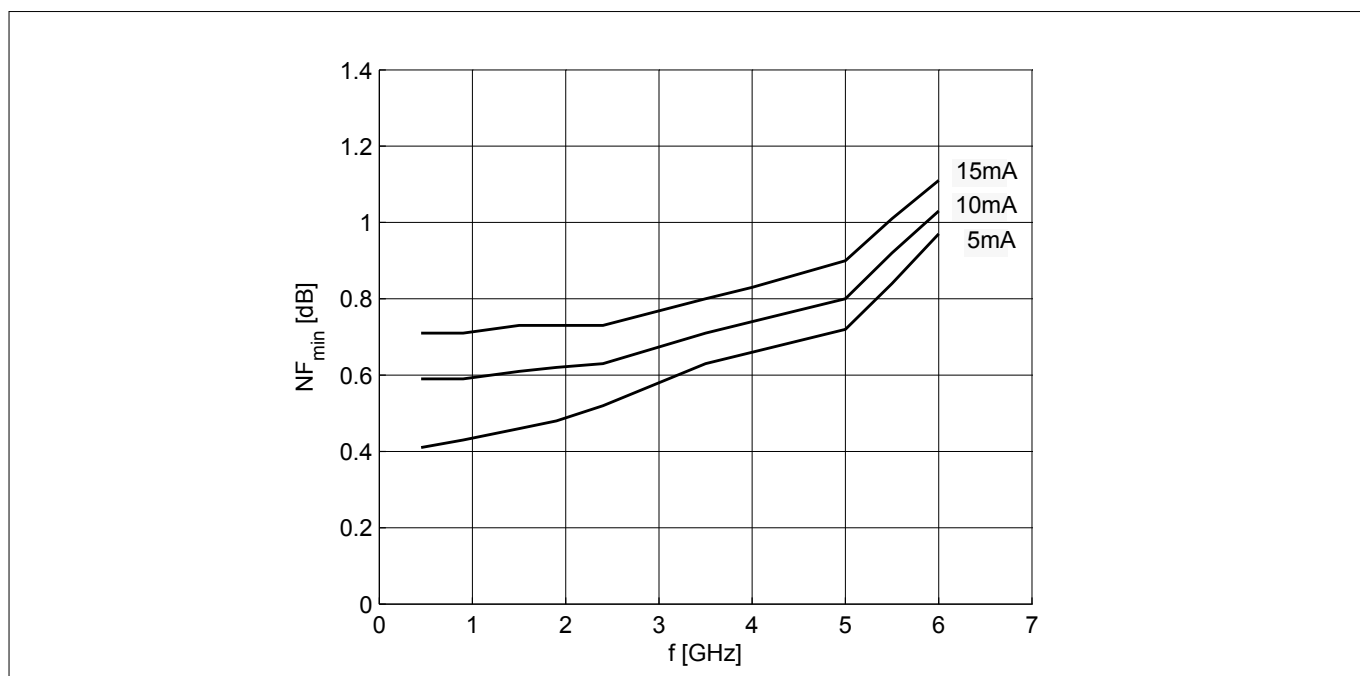


Figure 19 Noise figure $NF_{min} = f(f)$, $V_{CE} = 2.5 \text{ V}$, $Z_S = Z_{S,opt}$, $I_C = 5 / 10 / 15 \text{ mA}$

Electrical characteristics

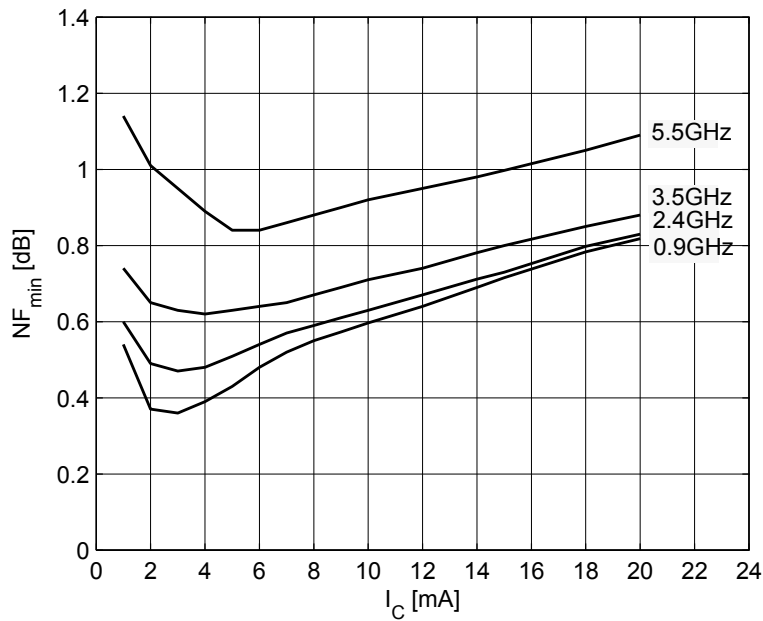


Figure 20 Noise figure $NF_{min} = f(I_C)$, $V_{CE} = 2.5$ V, $Z_S = Z_{S,opt}$, $f = \text{parameter}$

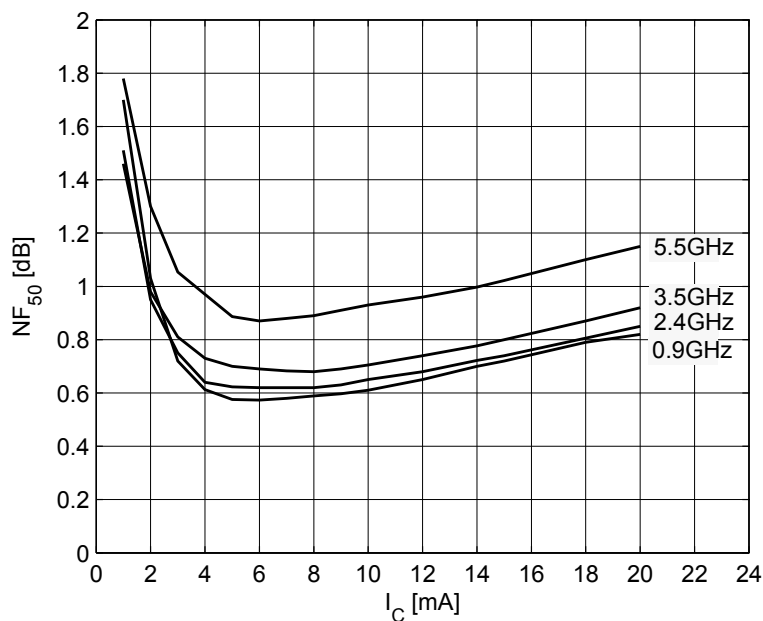


Figure 21 Noise figure $NF_{50} = f(I_C)$, $V_{CE} = 2.5$ V, $Z_S = 50 \Omega$, $f = \text{parameter}$

Note: The curves shown in this chapter have been generated using typical devices but shall not be considered as a guarantee that all devices have identical characteristic curves. $T_A = 25^\circ\text{C}$.

4 Package information SOT343

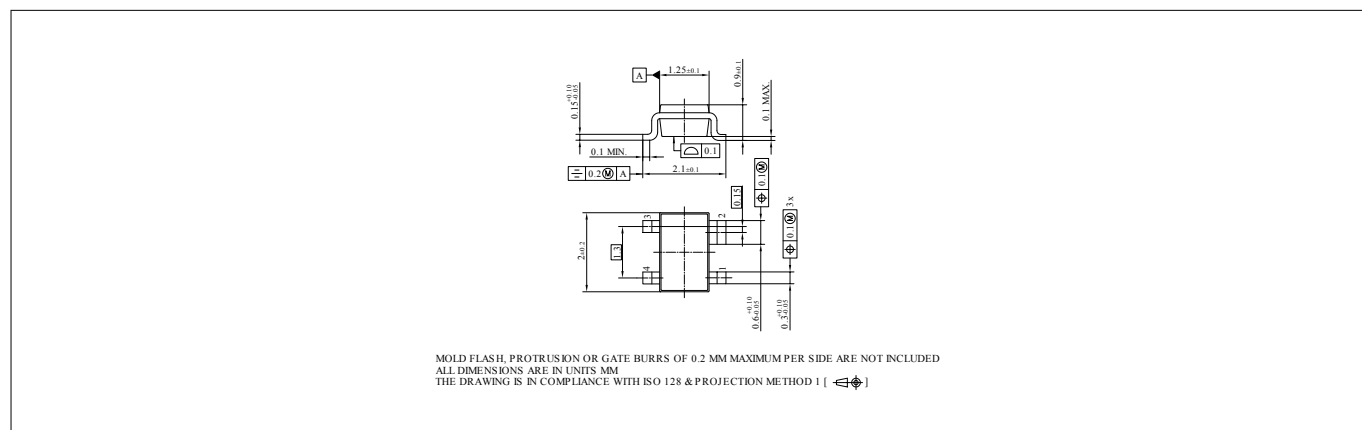


Figure 22 Package outline

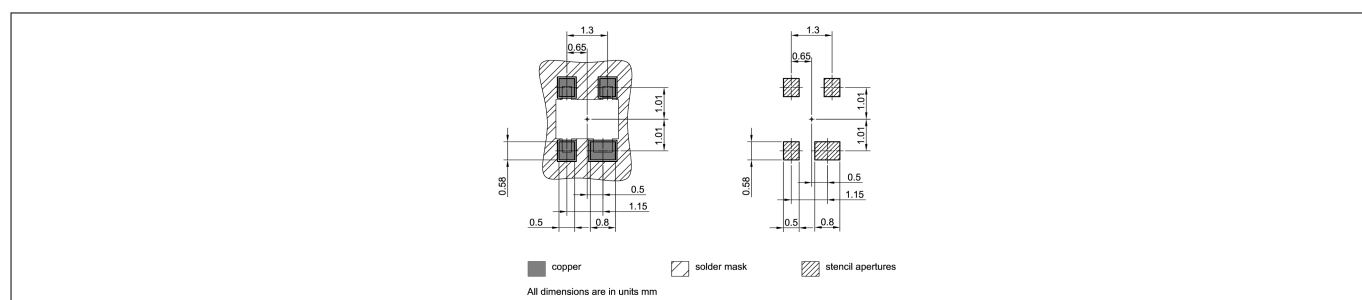


Figure 23 Foot print

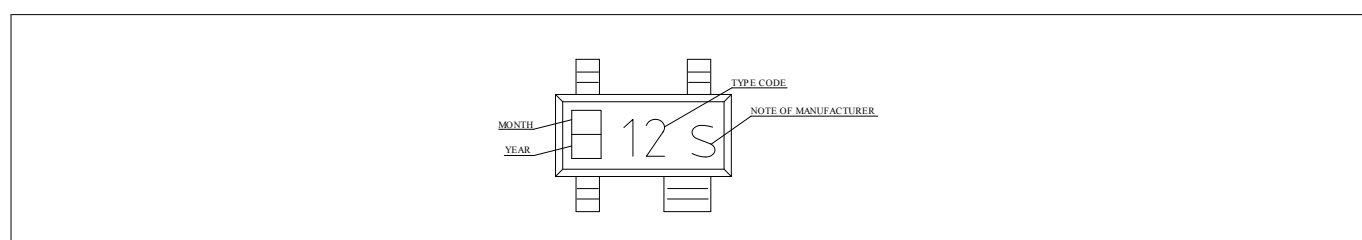


Figure 24 Marking layout example

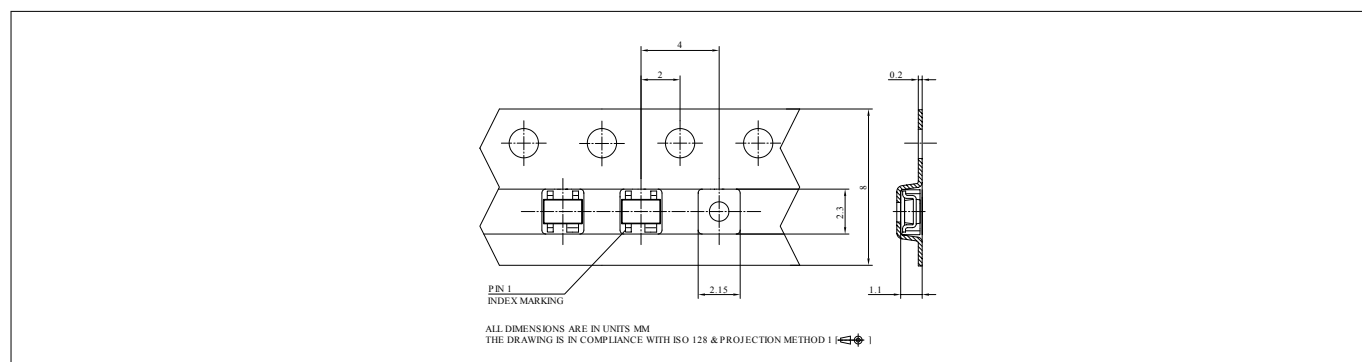


Figure 25 Tape dimensions

Revision history

Revision history

Document version	Date of release	Description of changes
2.0	2018-09-26	New datasheet layout.

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